

General Description

The 12P10S uses advanced trench technology and design to provide excellent RDS(ON) with low gate charge. It can be used in a wide variety of applications.

Features

- P-Channel
- Low ON-resistance.
- Fast Switching
- 100% avalanche tested

Absolute Maximum Ratings

Symbol	Parameter	Rating	Units
V_{DS}	Drain-Source Voltage	-100	V
V_{GS}	Gate-Source Voltage	± 30	V
$I_D@T_C=25^\circ C$	Continuous Drain Current	-9	A
I_{DM}	Pulsed Drain Current (Note 1)	-27	A
I_{AR}	Avalanche Current (Note 1)	-9	A
$P_D@T_C=25^\circ C$	Total Power Dissipation	40	W
T_{STG}	Storage Temperature Range	-55 to 150	$^\circ C$
T_J	Operating Junction Temperature Range	-55 to 150	$^\circ C$

Thermal Data

Symbol	Parameter	Typ.	Max.	Unit
$R_{\theta JA}$	Thermal Resistance Junction-ambient	---	50	$^\circ C/W$
$R_{\theta JC}$	Thermal Resistance Junction-case	---	2.5	$^\circ C/W$

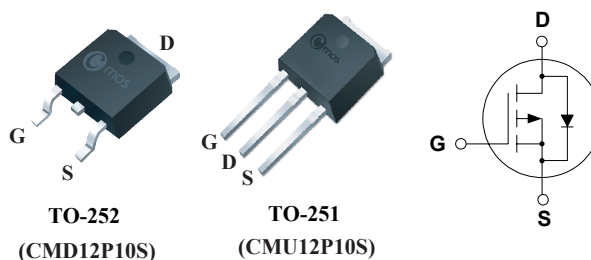
Product Summary

BVDSS	RDSON	ID
-100V	0.24 Ω	-9A

Applications

- Power Switch
- DC / DC converter

TO-252/251 Pin Configuration



Electrical Characteristics (T_J=25 °C, unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V, I _D =-250uA	-100	---	---	V
R _{DS(ON)}	Static Drain-Source On-Resistance	V _{GS} =-10V, I _D =-6A	---	---	0.24	Ω
V _{GS(th)}	Gate Threshold Voltage	V _{GS} =V _{DS} , I _D =-250uA	-1	---	-3	V
I _{DSS}	Drain-Source Leakage Current	V _{DS} =-100V, V _{GS} =0V	---	---	-1	uA
		V _{DS} =-80V, T _C =125°C	---	---	-10	
I _{GSS}	Gate-Source Leakage Current	V _{GS} =±20V, V _{DS} =0V	---	---	±100	nA
g _{fs}	Forward Transconductance	V _{DS} =-20V, I _D =-10A (Note 2)	---	12	---	S
Q _g	Total Gate Charge	I _D =-9A V _{DS} =-80V V _{GS} =-10V (Note 2, 3)	---	18	---	nC
Q _{gs}	Gate-Source Charge		---	4	---	
Q _{gd}	Gate-Drain Charge		---	8	---	
T _{d(on)}	Turn-On Delay Time	V _{DS} =-50V I _D =-9A R _G =25Ω (Note 2, 3)	---	13	---	ns
T _r	Rise Time		---	140	---	
T _{d(off)}	Turn-Off Delay Time		---	30	---	
T _f	Fall Time		---	50	---	
C _{iss}	Input Capacitance	V _{DS} =-25V, V _{GS} =0V, f=1MHz	---	1300	---	pF
C _{oss}	Output Capacitance		---	120	---	
C _{rss}	Reverse Transfer Capacitance		---	30	---	

Diode Characteristics

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
t _{rr}	Reverse Recovery Time	I _S =-9A, V _{GS} =0V dI/dt=-100A/μs (Note 2)	---	105	---	ns
Q _{rr}	Reverse Recovery Charge		---	0.4	---	μC
V _{SD}	Diode Forward Voltage	V _{GS} =0V, I _S =-12A	---	---	-1.2	V

Notes:

1. Repetitive Rating : Pulse width limited by maximum junction temperature
2. Pulse Test : Pulse width ≤ 300 μs, Duty cycle ≤ 2%
3. Essentially independent of operating temperature

This product has been designed and qualified for the consumer market.
Cmos assumes no liability for customers' product design or applications.
Cmos reserves the right to improve product design, functions and reliability without notice.